

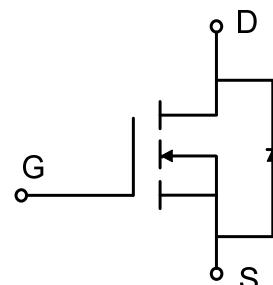
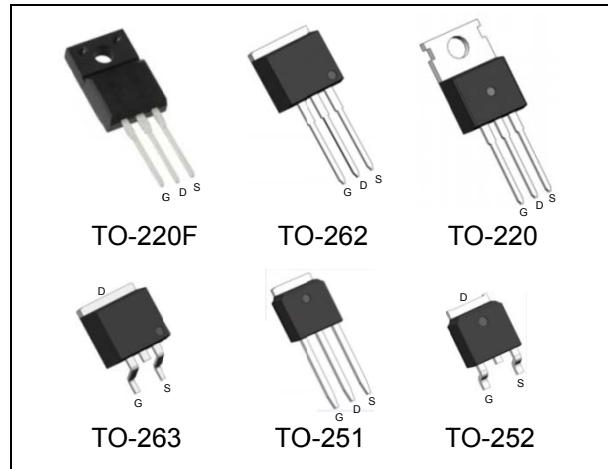
600V 0.27Ω Super Junction Power MOSFET

Description

WMOS™ C2 is Wayon's 2nd generation super junction MOSFET family that is utilizing charge balance technology for extremely low on-resistance and low gate charge performance. WMOS™ C2 is suitable for applications which require superior power density and outstanding efficiency.

Features

- $V_{DS} = 650V @ T_{j,max}$
- Typ. $R_{DS(on)} = 0.27\Omega$
- 100% UIS tested
- Pb-free plating, Halogen free

**Applications**

LED Lighting, Charger, Adapter, PC, LCD TV, Server

Absolute Maximum Ratings

Parameter	Symbol	WMK/WMM/WMO/WMP/WMN	WML	Unit
Drain-source voltage	V_{DSS}	600		V
Continuous drain current ¹⁾ ($T_C = 25^\circ\text{C}$)	I_D	13		A
($T_C = 100^\circ\text{C}$)		7.8		A
Pulsed drain current ²⁾	I_{DM}	26		A
Gate-source voltage	V_{GS}	± 30		V
Avalanche energy, single pulse ³⁾	E_{AS}	145		mJ
Avalanche energy, repetitive ²⁾	E_{AR}	0.21		mJ
Avalanche current, repetitive ²⁾	I_{AR}	2		A
Power dissipation ($T_C = 25^\circ\text{C}$)	P_D	86	31	W
- Derate above 25°C		0.69	0.25	W/°C
Operating and storage temperature range	T_j, T_{stg}	-55 to +150		°C
Continuous diode forward current	I_S	13		A
Diode pulse current	$I_{S,pulse}$	26		A

Thermal Characteristics

Parameter	Symbol	WMK/WMM/WMO/WMP/WMN	WML	Unit
Thermal resistance, junction-to-case	$R_{\theta JC}$	1.45	4	°C/W
Thermal resistance, junction-to-ambient	$R_{\theta JA}$	62	80	°C/W

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}}=0 \text{ V}, I_{\text{D}}=0.25 \text{ mA}$	600	-	-	V
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=0.25 \text{ mA}$	2.5	3.3	4.5	V
Drain cut-off current	I_{DSS}	$V_{\text{DS}}=600 \text{ V}, V_{\text{GS}}=0 \text{ V},$ $T_j = 25^\circ\text{C}$ $T_i = 125^\circ\text{C}$	-	-	1	μA
Gate leakage current, forward	I_{GSSF}	$V_{\text{GS}}=30 \text{ V}, V_{\text{DS}}=0 \text{ V}$	-	-	100	nA
Gate leakage current, reverse	I_{GSSR}	$V_{\text{GS}}=-30 \text{ V}, V_{\text{DS}}=0 \text{ V}$	-	-	-100	nA
Drain-source on-state resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10 \text{ V}, I_{\text{D}}=5.5 \text{ A}$ $T_j = 25^\circ\text{C}$	-	0.27	0.32	Ω
Dynamic characteristics						
Input capacitance	C_{iss}	$V_{\text{DS}}=25 \text{ V}, V_{\text{GS}}=0 \text{ V},$ $f = 1 \text{ MHz}$	-	992	-	pF
Output capacitance	C_{oss}		-	595	-	
Reverse transfer capacitance	C_{rss}		-	1.4	-	
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 300 \text{ V}, I_{\text{D}} = 5.5 \text{ A}$ $R_G = 25 \Omega, V_{\text{GS}}=10 \text{ V}$	-	28	-	ns
Rise time	t_r		-	17	-	
Turn-off delay time	$t_{\text{d}(\text{off})}$		-	78	-	
Fall time	t_f		-	20	-	
Gate charge characteristics						
Gate to source charge	Q_{gs}	$V_{\text{DD}}=480 \text{ V}, I_{\text{D}}=5.5 \text{ A},$ $V_{\text{GS}}=0 \text{ to } 10 \text{ V}$	-	4.9	-	nC
Gate to drain charge	Q_{gd}		-	7.8	-	
Gate charge total	Q_g		-	19.9	-	
Gate plateau voltage	V_{plateau}		-	5.4	-	V
Reverse diode characteristics						
Diode forward voltage	V_{SD}	$V_{\text{GS}}=0 \text{ V}, I_{\text{F}}=5.5 \text{ A}$	-	-	1.2	V
Reverse recovery time	t_{rr}	$V_R=50 \text{ V}, I_{\text{F}}=5.5 \text{ A},$ $dI_{\text{F}}/dt=100 \text{ A}/\mu\text{s}$	-	264	-	ns
Reverse recovery charge	Q_{rr}		-	2.07	-	μC
Peak reverse recovery current	I_{rrm}		-	16	-	A

Notes:

1. Limited by $T_{j\max}$. Maximum duty cycle D=0.5.
2. Repetitive rating: pulse width limited by maximum junction temperature.
3. $I_{AS} = 2 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$, starting $T_j = 25^\circ\text{C}$.

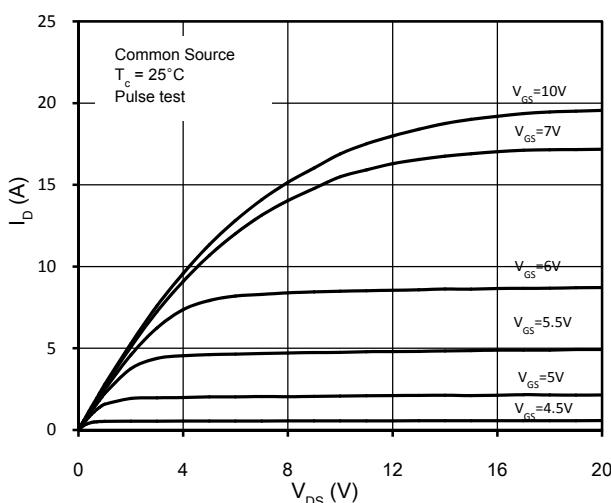


Figure 1. On-Region Characteristics

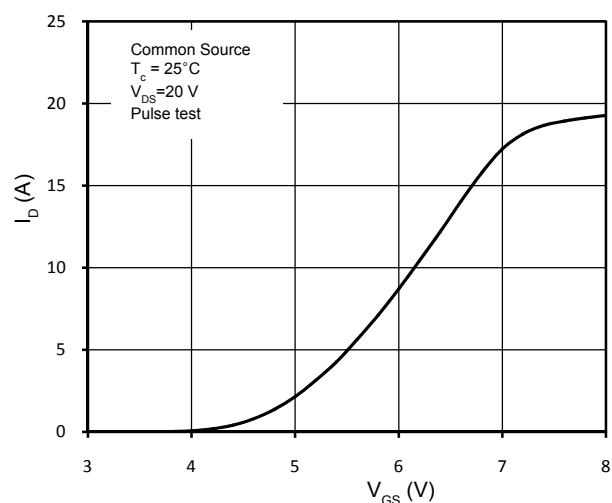


Figure 2. Transfer Characteristics

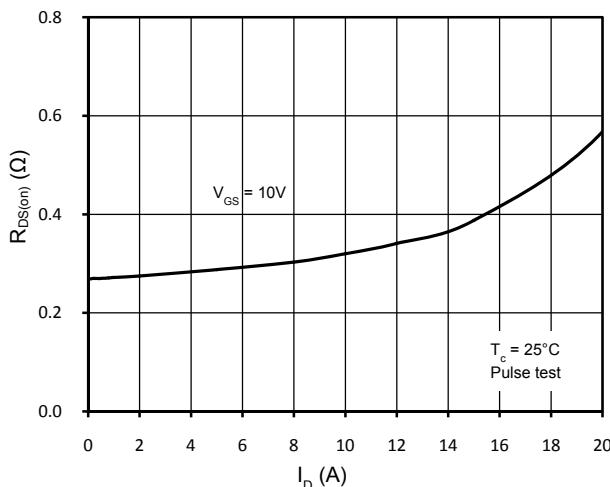


Figure 3. Static Drain-Source On Resistance

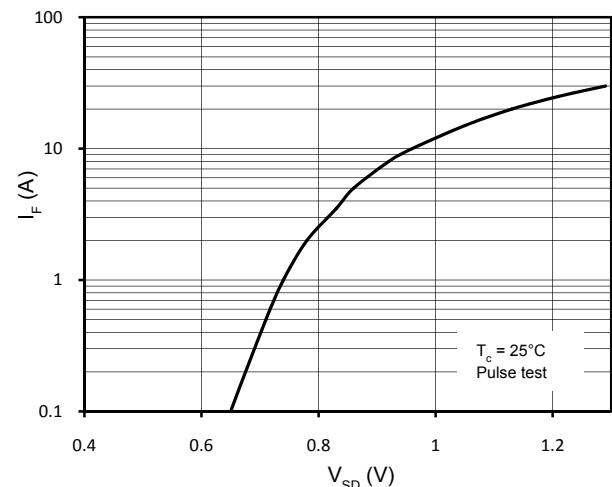
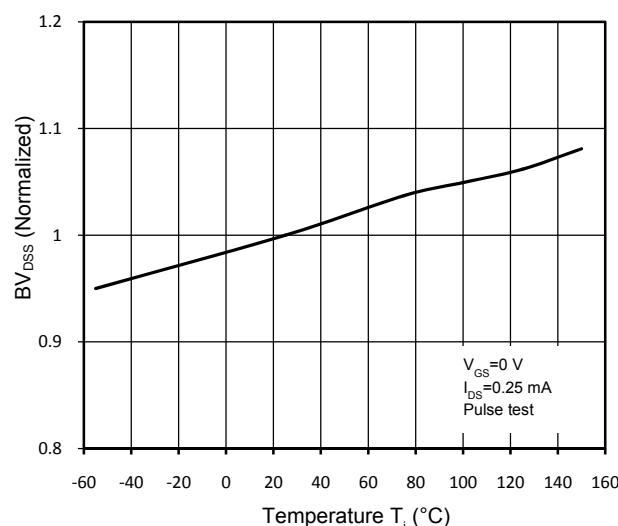
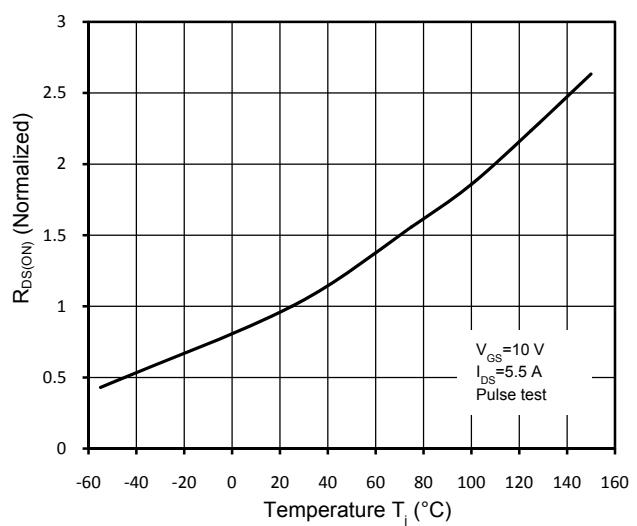


Figure 4. Body-Diode Forward Characteristics

Figure 5. Normalized BV_{DS} vs. TemperatureFigure 6. Normalized $R_{DS(on)}$ vs. Temperature

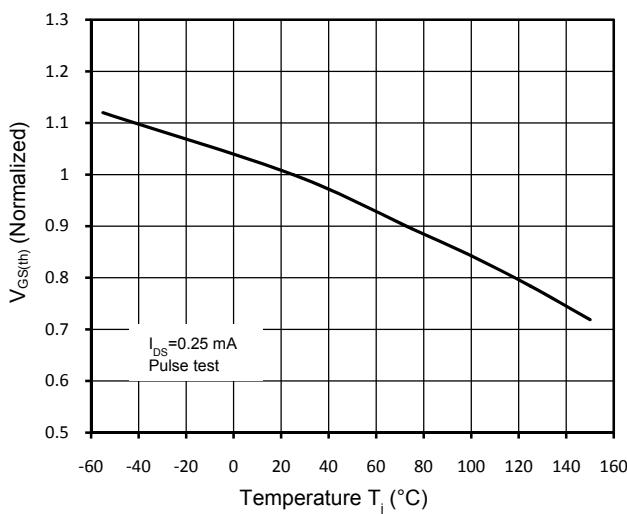


Figure 7. Threshold Voltage vs. Temperature

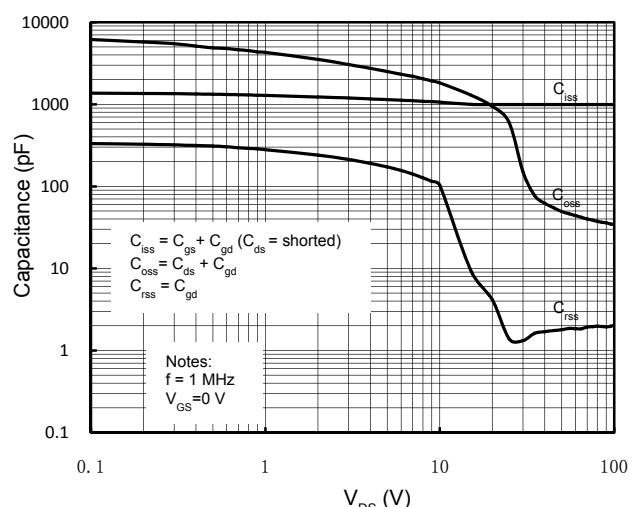


Figure 8. Capacitance Characteristics

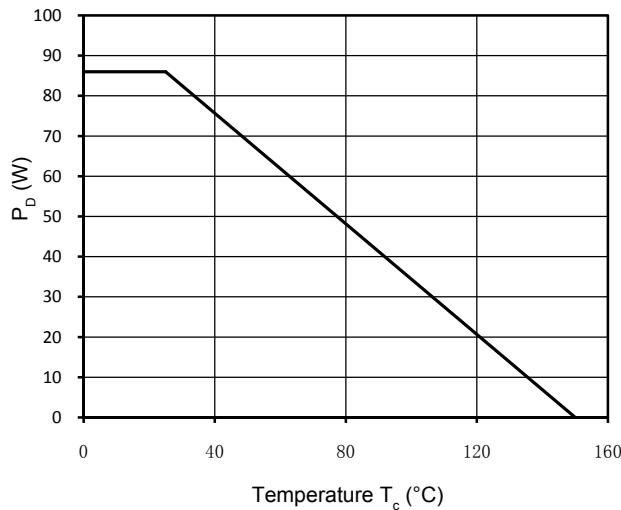


Figure 9. Power Dissipation

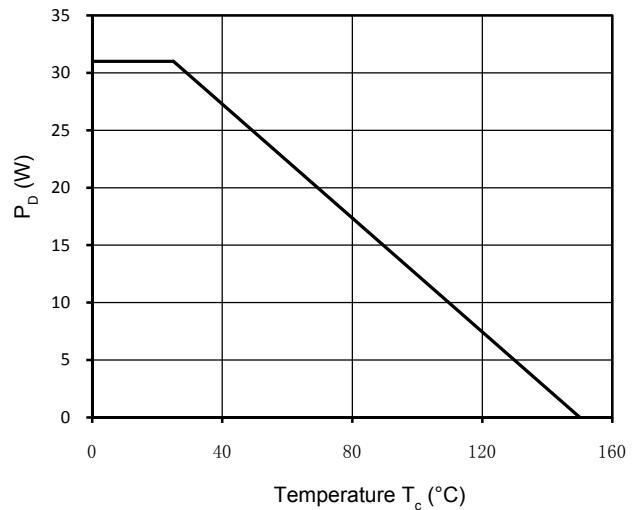


Figure 10. Power Dissipation (TO-220F)

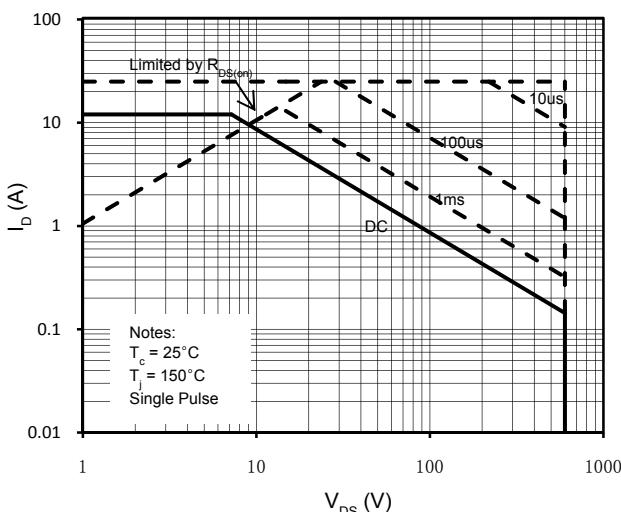


Figure 11. Maximum Safe Operating Area

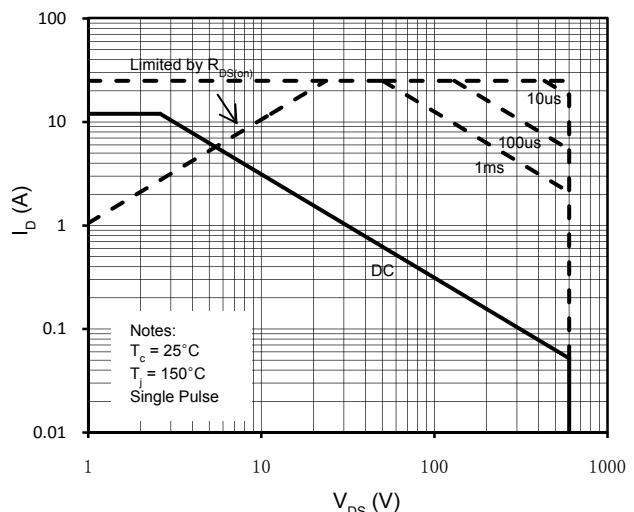


Figure 12. Maximum Safe Operating Area(TO-220F)

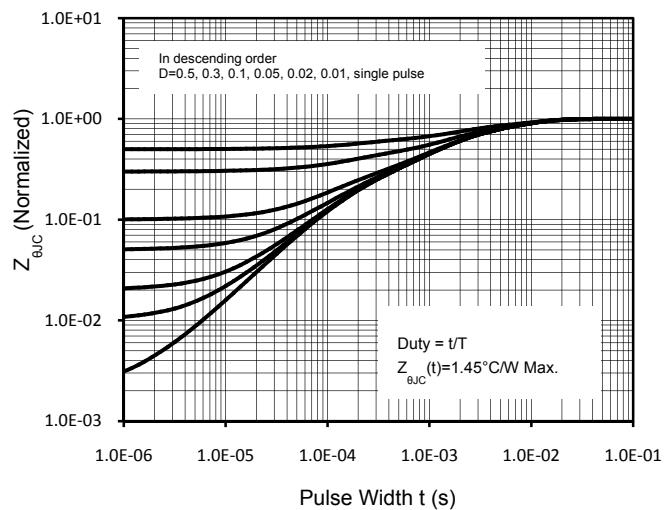
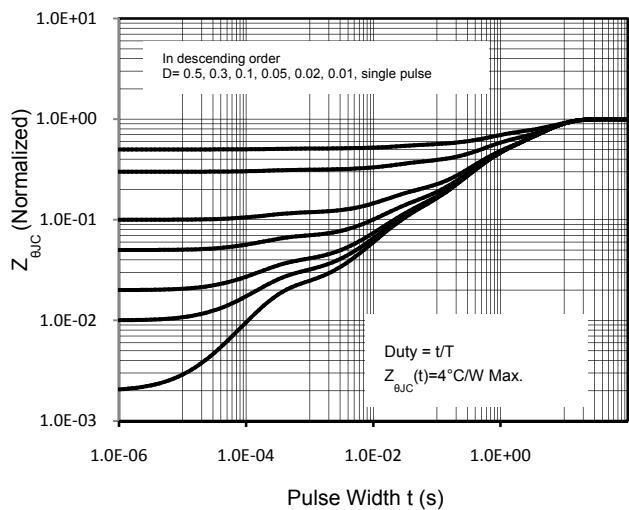


Figure 13. Transient Thermal Response Curve (TO-220F) Figure 14. Transient Thermal Response Curve

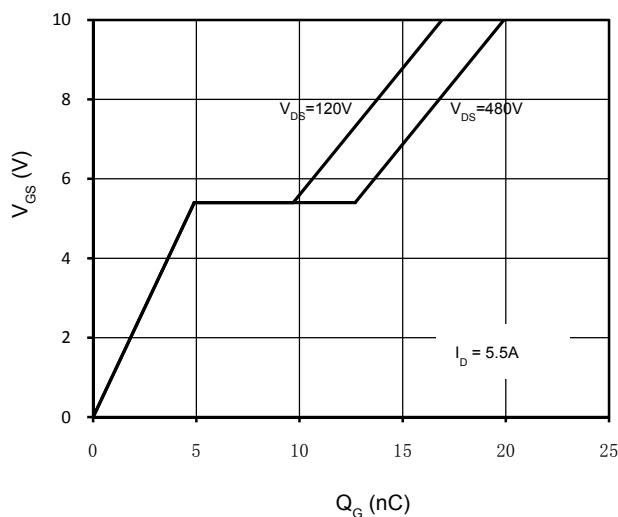
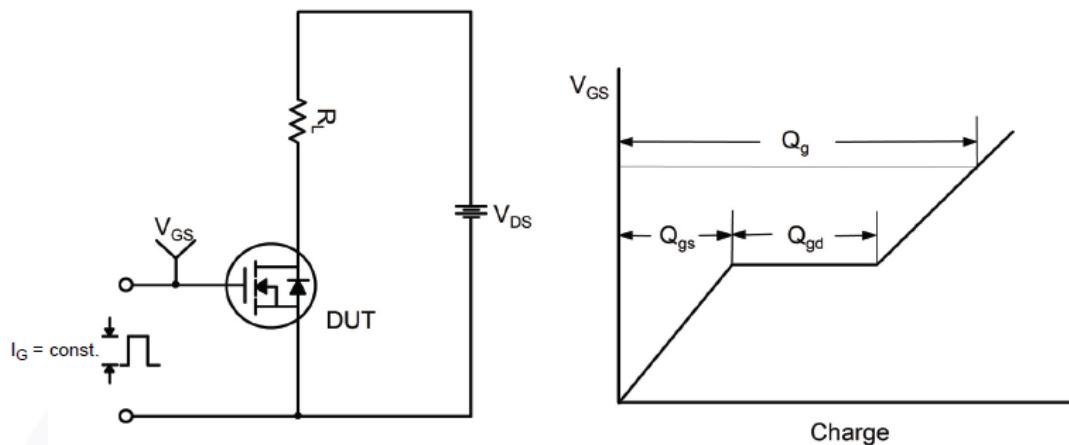
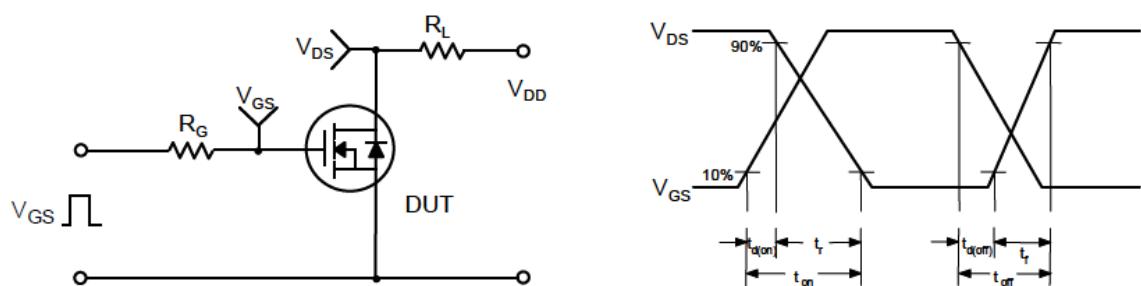


Figure 15. Gate Charge Characteristics

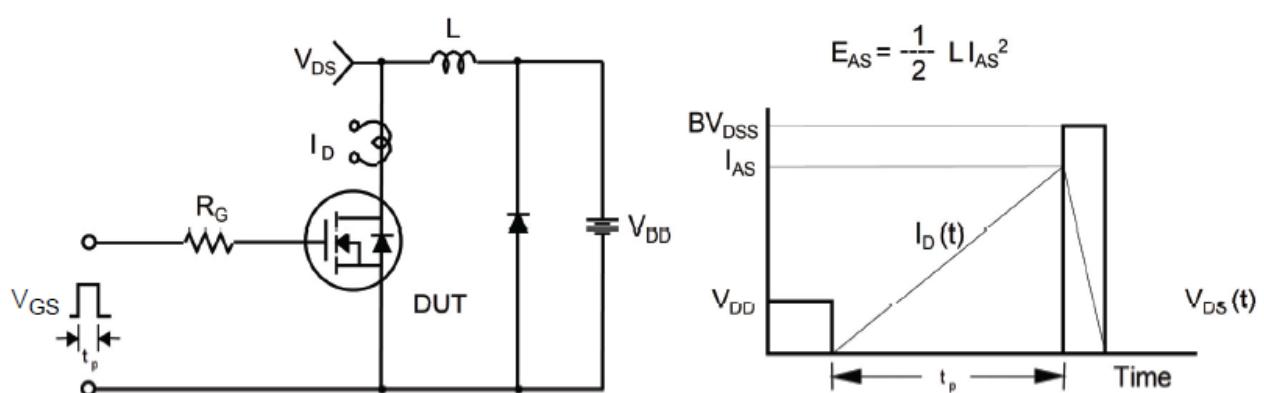
Gate Charge Test Circuit & Waveform

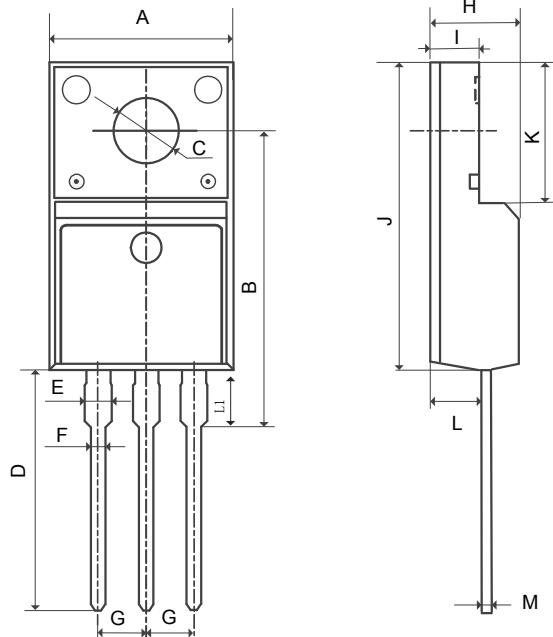


Switching Test Circuit & Waveforms

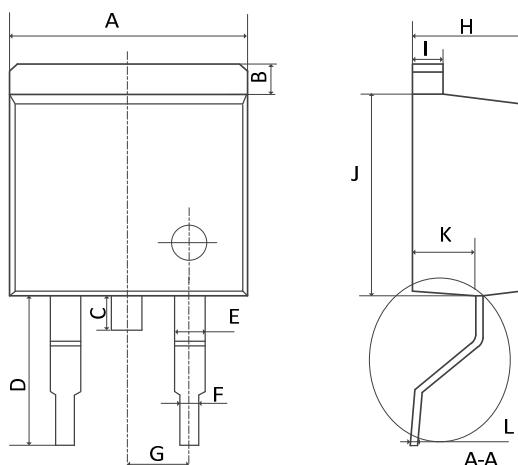


Unclamped Inductive Switching Test Circuit & Waveforms

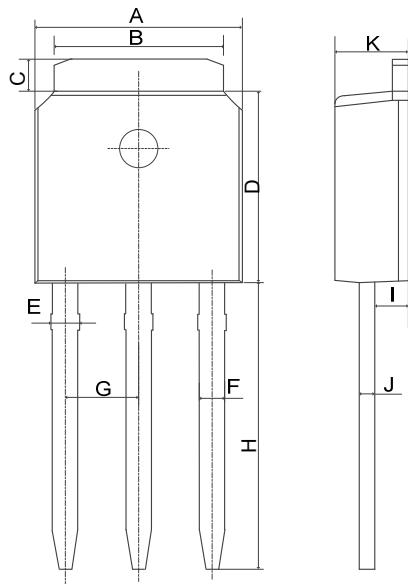


Mechanical Dimensions for TO-220F**COMMON DIMENSIONS**

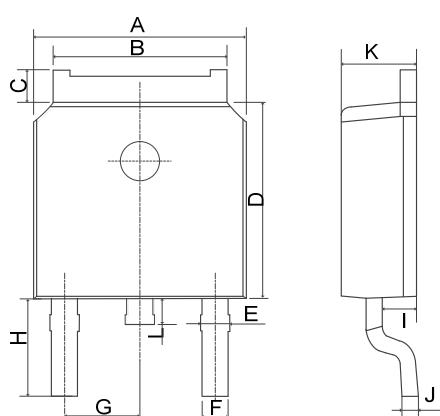
SYMBOL	MM	
	MIN	MAX
A	9.96	10.36
B	15.10	16.10
C	3.03	3.38
D	12.64	13.28
E	1.18	1.58
F	0.70	0.95
G	2.54REF	
H	4.50	4.90
I	2.34	2.74
J	15.57	16.17
K	6.70REF	
L	2.56	2.96
M	0.40	0.65
L1	2.85	3.45

Mechanical Dimensions for TO-263**COMMON DIMENSIONS**

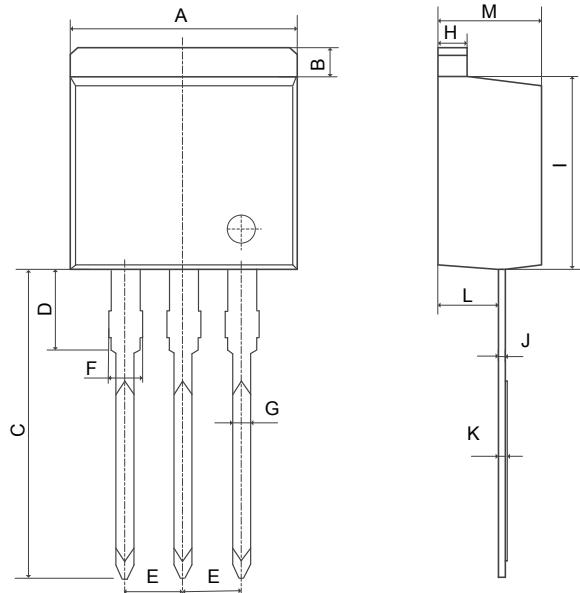
SYMBOL	MM	
	MIN	MAX
A	10.00	10.40
B	1.11	1.41
C	1.25	1.55
D	5.10	5.50
E	1.12	1.42
F	0.71	0.92
G	2.39	2.69
H	4.49	4.89
I	1.17	1.37
J	8.45	8.85
K	2.54	2.84
L	0.28	0.49

Mechanical Dimensions for TO-251**COMMON DIMENSIONS**

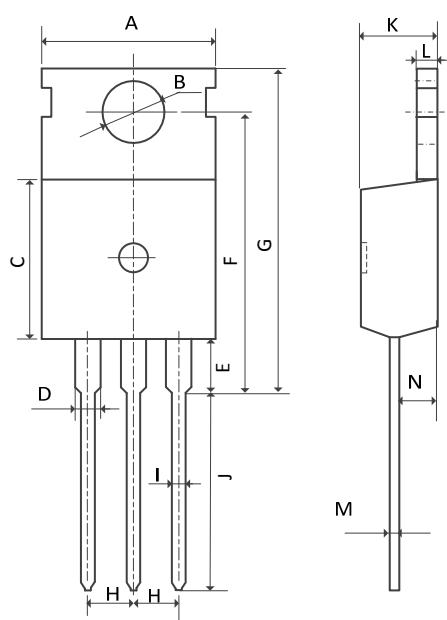
SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.13	5.46
C	0.88	1.28
D	5.90	6.22
E	0.68	1.10
F	0.68	0.91
G	2.29REF	
H	9.00	9.65
I	0.90	1.17
J	0.40	0.61
K	2.10	2.50

Mechanical Dimensions for TO-252**COMMON DIMENSIONS**

SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.13	5.50
C	0.88	1.28
D	5.90	6.22
E	0.68	1.10
F	0.68	0.91
G	2.29REF	
H	2.90REF	
I	0.85	1.17
J	0.51REF	
K	2.10	2.50
L	0.40	1.00

Mechanical Dimensions for TO-262**COMMON DIMENSIONS**

SYMBOL	MM	
	MIN	MAX
A	10.00	10.40
B	1.11	1.41
C	13.56	14.16
D	3.58	3.98
E	2.39	2.69
F	1.07	1.47
G	0.71	0.92
H	1.17	1.37
I	8.45	8.85
J	0.28	0.49
K	0.32	0.52
L	2.54	2.85
M	4.50	4.90

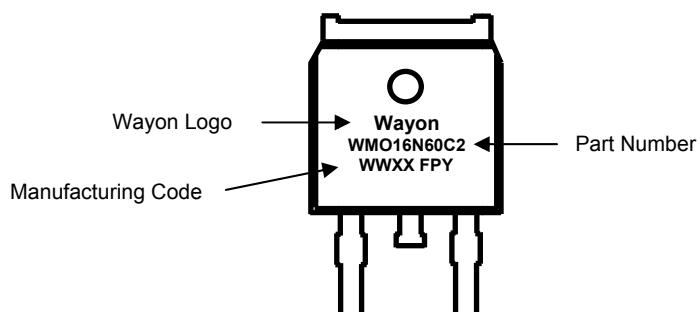
Mechanical Dimensions for TO-220**COMMON DIMENSIONS**

SYMBOL	MM	
	MIN	MAX
A	9.70	10.20
B	3.40	3.80
C	8.90	9.40
D	1.17	1.47
E	2.60	3.40
F	15.10	16.70
G	19.55MAX	
H	2.54REF	
I	0.70	0.95
J	9.35	11.00
K	4.30	4.77
L	1.20	1.45
M	0.40	0.65
N	2.20	2.60

Ordering Information

Part	Package	Marking	Packing method
WML16N60C2	TO-220F	WML16N60C2	Tube
WMK16N60C2	TO-220	WMK16N60C2	Tube
WMN16N60C2	TO-262	WMN16N60C2	Tube
WMM16N60C2	TO-263	WMM16N60C2	Tape and Reel
WMO16N60C2	TO-252	WMO16N60C2	Tape and Reel
WMP16N60C2	TO-251	WMP16N60C2	Tube

Marking Information



Contact Information

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WAYON website: <http://www.way-on.com>

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